

**IN THE CLAIMS:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

Claims 3-5 and 7 have been amended as follows:

Listing of Claims:

**Claim 1 (Original):** A polypropylene-based resin composition for metallized films, comprising:

(A) 100 parts by weight of a propylene random copolymer having the properties (a-1) to (a-5):

(a-1) propylene unit present at 88 to 99.5% by mol, and ethylene and/or butene structural unit present at 0.5 to 12% by mol,

(a-2) melt flow rate ( $MFR_A$ ) of 1 to 30g/10 minutes,

(a-3) polydispersity index (PI), determined by the melt viscoelasticity analysis, of 2.4 to 4,

(a-4) solubles contained at 20°C or lower, determined by cross fractionation chromatography (CFC), at 1.5% by weight or less, and the solubles having a weight-average molecular weight of  $0.1 \times 10^4$  to  $6.0 \times 10^4$ , and

(a-5) solubles contained at 40°C or lower, determined by cross fractionation chromatography (CFC), at 4.0% by weight or less, and the solubles having a weight-average molecular weight of  $0.1 \times 10^4$  to  $8.0 \times 10^4$ ,

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(B) 0.01 to 6 parts by weight of a polyethylene resin having a density of 0.945 to 0.980g/cm<sup>3</sup>, melt index (MI<sub>B</sub>) of 1 to 1000g/10 minutes, and ratio of MI<sub>B</sub> to MFR<sub>A</sub>, i.e., (MI<sub>B</sub>/MFR<sub>A</sub>) ratio, of 0.7 to 1000,

(C) 0.01 to 0.7 parts by weight of an antiblocking agent having an average particle size of 1.0 to 5.0μm and pore volume of 1.7mL/g or less,

(D) 0.01 to 0.5 parts by weight of an antioxidant having a molecular weight of 500 or more, and

(E) 0.005 to 0.5 parts by weight of a hydrotalcite-based compound.

**Claim 2 (Original):** The polypropylene-based resin composition according to Claim 1 for metallized films, wherein said propylene random copolymer (A) further has the property (a-6), and antiblocking agent (C) has a pore volume of 0.45mL/g or more and wear rate of 100mg or less:

(a-6) melting point (Tp), determined by differential scanning calorimetry (DSC), of 115 to 150°C.

**Claim 3 (Currently Amended):** The polypropylene-based resin composition according to Claim 1 [[or 2]] for metallized films, wherein said antioxidant (D) is a phenol- and/or phosphorus-based one.

**Claim 4 (Currently Amended):** The polypropylene-based resin composition according to

~~one of Claims 1 to 3~~ Claim 1 for metallized films, wherein said propylene random copolymer (A) is produced in the presence of a metallocene catalyst.

**Claim 5 (Currently Amended):** A film for metallization, composed of the polypropylene-based resin composition according to ~~one of Claims 1 to 4~~ Claim 1 for metallized films.

**Claim 6 (Original):** The film according to Claim 5 for metallization, satisfying the following relationship:

$$730 \leq 14 \times [\text{HST}] - [\text{YM}] \leq 1340 \quad (1)$$

(wherein, [HST] is a heat seal temperature (unit: °C) at which the load is 3N, and [YM] is a tensile modulus (unit: MPa) of the film).

**Claim 7 (Currently Amended):** A metallized film comprising the film according to Claim 5 [[or 6]] for metallization, metallized with a metal and/or its oxide.

**Claim 8 (New):** The polypropylene-based resin composition according to Claim 2 for metallized films, wherein said antioxidant (D) is a phenol- and/or phosphorus-based one.

**Claim 9 (New):** The polypropylene-based resin composition according to Claim 2 for metallized films, wherein said propylene random copolymer (A) is produced in the presence of a

metallocene catalyst.

**Claim 10 (New):** A film for metallization, composed of the polypropylene-based resin composition according to Claim 2 for metallized films.

**Claim 11 (New):** A metallized film comprising the film according to Claim 10 for metallization, metallized with a metal and/or its oxide.

**Claim 12 (New):** A metallized film comprising the film according to Claim 6 for metallization, metallized with a metal and/or its oxide.